



N-Channel Reduced Q_g, Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
30	0.0085 at V _{GS} = 10 V	15			
	0.0125 at V _{GS} = 4.5 V	12			

SO-8 S 1 8 D S 2 7 D S 3 6 D Top View

Ordering Information: Si4384DY-T1-E3 (Lead (Pb)-free) Si4384DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

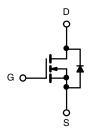
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Gen II Power MOSFETs
- PWM Optimized
- 100 % R_g Tested

ROHS COMPLIANT HALOGEN FREE Available

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Desktop
 - Server



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	30		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	I _D	15	10	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		12	8	
Pulsed Drain Current		I _{DM}	± 50		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.8	1.3	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	2	25	
Avalanche Energy	L = 0.1 MH	E _{AS}	31		mJ
Mariana Baran Biraha di ad	T _A = 25 °C T _A = 70 °C	- P _D	3.1	1.47	W
Maximum Power Dissipation ^a			2	0.95	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian In the Architect (MOCFET)	t ≤ 10 s	- R _{thJA}	34	40	°C/W
Maximum Junction-to-Ambient (MOSFET) ^a	Steady State		71	85	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	20	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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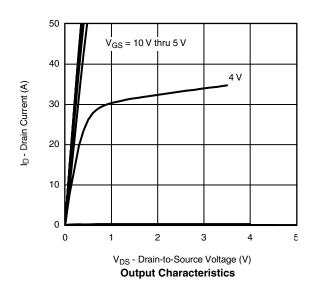
MOSFET SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	nbol Test Conditions		Тур.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	1		1	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α
	В	V _{GS} = 10 V, I _D = 15 A		0.007	0.0085	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$	V _{GS} = 4.5 V, I _D = 12 A		0.0125	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		56		S
Diode Forward Voltage ^a	V_{SD}	I _S = 2.8 A, V _{GS} = 0 V		0.75	1.1	V
Dynamic ^b				•	•	
Total Gate Charge	Q_g			12	18	
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 15 \text{ A}$		5.9		nC
Gate-Drain Charge	Q_{gd}			4.0		
Gate Resistance	R_{g}		0.8	1.7	2.5	Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		13	20	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong\text{1 A, V}_\text{GEN}=\text{10 V, R}_\text{g}=\text{6}~\Omega$		45	70	ns
Fall Time	t _f			13	20	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.8 A, dI/dt = 100 A/μs		25	50	

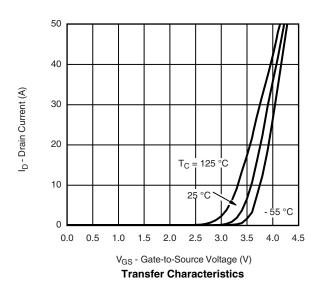
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

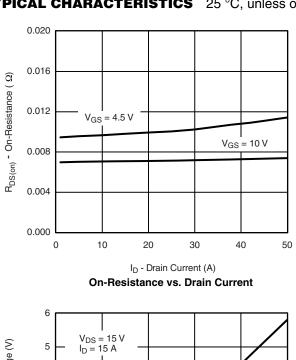
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

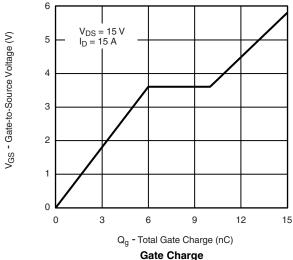


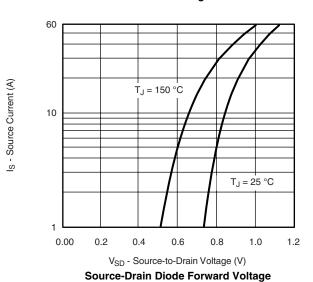


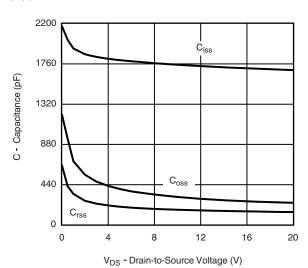


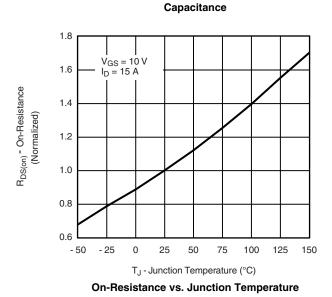
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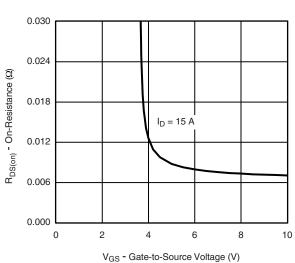










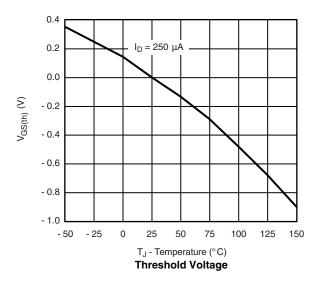


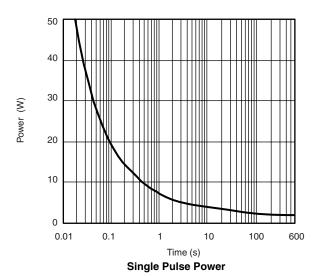
On-Resistance vs. Gate-to-Source Voltage

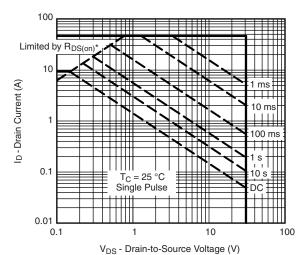
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

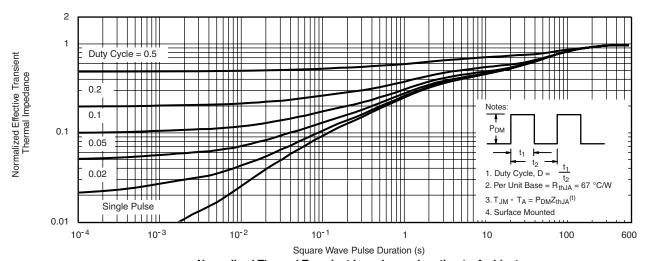






* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

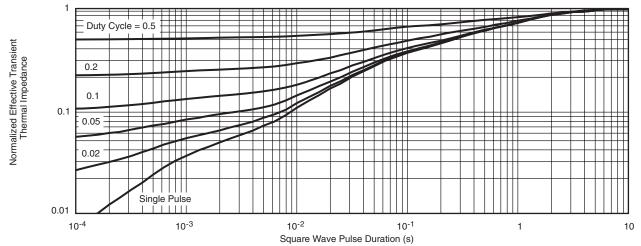
Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



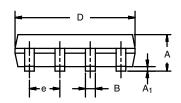
Normalized Thermal Transient Impedance, Junction-to-Foot

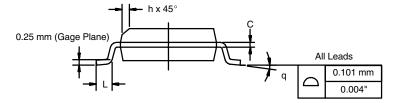
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050) BSC	
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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